



IEEE International 3D System Integration Conference 2014
December 1—3,
2014
Kinsale, Cork,
Ireland

Exhibit Prospectus

Your Customers and Competition will be there—Make sure you are too!

You are invited to exhibit at the

IEEE International 3D System Integration Conference 2014

Actons Hotel Kinsale, Cork

Official Invitation from the Conference Chair

Greetings potential 3DIC exhibitors,

In 2014 the global IEEE Conference is being held in Kinsale, Cork, Ireland.

3DIC will cover all 3DIC topics, including 3D process technology, materials, equipment, circuits technology, design methodology and applications. The conference invites authors and attendees to submit and interact with 3D researchers from all around the world. Papers are solicited in subject topics, including, but not limited to, the following:

3D IC Technology: Through Silicon Vias (TSV), wafer thinning, wafer alignment, wafer bonding, wafer dicing, 3D IC process, monolithic 3D integration, heterogeneous 3D integration, Capacitive coupling, Inductive coupling, multilevel epitaxial growth, etc.

3D IC Circuits Technology: 3D SOC, 3D Memory, 3D Processor, 3D DSP, 3D FPGA, 3D RF and microwave/millimeter wave, 3D analog circuits, 3D Biomedical circuits etc.

3D Applications: imaging, memory, processors, communications, networking, wireless, biomedical etc.

3D Design Methodology: 3D CAD, 3D synthesis, 3D design flows, Signal and power integrity analysis and design in 3D, 3D thermal design and analysis, test and design for test; 3D mechanical stress and reliability design and analysis, etc.

If you are a materials or equipment supplier; supply 2.5/3D design, assembly or test; are a 2.5/3D foundry or OSAT this is the place you will want to exhibit.

We expect a full house for this IEEE sponsored 3DIC meeting and we hope you will be there.

Regards,

Peter Ramm – Fraunhofer EMFT

Eric Beyne – IMEC

Chairmen – IEEE 3DIC 2014

Conference Highlights

CONFERENCE SCOPE

This conference combines the previous ASET and IEEE EDS Society sponsored International 3D System Integration Conference, held in Tokyo in 2007 & 2008 and the IEEE CPMT sponsored 3D System Integration Conference held in 2005 & 2007 in Munich. The new, combined CPMT sponsored Conference will continue rotating between the three continents. 3D IC will cover all 3D IC topics, including 3D process technology, materials, equipment, circuits technology, design methodology and applications. The conference invites authors and attendees to submit and interact with 3D researchers from all around the world. Papers are solicited in subject topics, including, but not limited to, the following:

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OFFICIAL CONFERENCE DATES

Dec 1—3, 2014

LOCATION

Actons Hotel, Kinsale, Cork Ireland

Exhibit Fee—€1000

YOUR EXHIBIT FEE INCLUDES:

- 1 – 6' draped table
- 2 – Chairs

TENTATIVE HOURS

	DAY	START	END
Exhibitor move-in:	Monday, 1 December	12:00PM	5:00PM
Exhibit Hours:	Tuesday, 2 December	8:00AM	5:00PM
Exhibit Hours:	Wednesday, 3 December	8:00AM	3:00PM
Exhibitor move-out:	Wednesday, 3 December	8:00PM	5:00PM

Interested in Exhibiting?

Contact:

3dic-conf-cork@tyndall.ie

Terms and Conditions

This application, properly executed by Applicant (Exhibitor) shall, upon written acceptance and notification of booths assigned by 3DIC 2014 management, constitute a valid and binding contract.

Space Assignments

Assignment of space to exhibitors is made on a first come/first served basis. 3DIC 2014 will continue to receive applications and assign Exhibit space, as it remains available, until shortly before the show opening date. In all cases, total booth payments must be received prior to show opening. 3DIC 2014's assignment of booths is final and shall constitute an acceptance of the Exhibitor's offer to occupy space. After assignment, space location may not be changed, transferred or cancelled by the Exhibitor except upon written request and with the subsequent written approval of 3DIC 2014 management. 3DIC 2014 management reserves the right to reassign Exhibitor space or to modify floor plan for overall benefit of the show.

Subletting Space

No exhibitor will assign, sublet, or apportion the whole or any part of the space allotted to him, nor exhibit therein, nor permit any other person or party to exhibit therein, any other goods, apparatus, etc. not manufactured or distributed by the Exhibitor in the regular course of his business except upon prior written consent of 3DIC 2014 Management.

Exhibit Space Rental Fee

Exhibit space rental includes materials and services described herein.

Price Per Booth: Basic booth price €1,000 and includes a 6ft skirted table with (2) chairs.

Payment Requirements and Cancellation Charges

Applications require 100% payment before final booth assignment is confirmed in writing. All cancellations must be made in writing and will be based on the following schedule of refunds:

On or before Nov 1st 2014 90% of total booth cost will be refunded. After Nov 1st 2014 no refunds will be permitted. "No-show" exhibitors will not receive a refund. Space reductions are considered cancellations and are subject to cancellation fees. It is understood that 3DIC 2014 reserves the right, at its option, to reassign a cancelled booth regardless of the cancellation rate assessed.

In the event that the premise in which the 3DIC 2014 show is conducted shall become, in the sole discretion of 3DIC 2014, unfit for occupancy, or substantially interfered with by reason of any cause or causes not reasonably within the control of 3DIC 2014, this agreement may be terminated by 3DIC 2014. For this purpose, the term "cause or causes" shall include, but not by way of limitation, fire, flood, epidemic, earthquake, explosion or accident, blockage, embargo, inclement weather, governmental restraints, restraints or orders of civil defense, or military authorities, act of public enemy, riot or civil disturbance, strike, lockout, boycott or other labor disturbance, inability to secure sufficient labor, technical or other personnel, failure, impairment or lack of adequate transportation facilities, inability to obtain, or condemnation, requisition or commandeering of necessary supplies or equipment, local, state or federal law, ordinance, rule, order, decree or regulation, whether legislative, executive, or judicial, and whether constitutional, or act of God. Should 3DIC 2014 terminate this agreement pursuant to the provision of this paragraph the Exhibitor waives any and all claims for damages and agrees that 3DIC 2014 may, after computing the total amount of 3DIC 2014 cost and expenses in connection with its preparation for and conducting of the 3DIC 2014 Show, (including a reasonable reserve for claims and other contingencies), refund to the exhibitor, as and for complete settlement and discharge of all said Exhibitor's claims and demands, an amount which bears the same relationship to the fee paid by said Exhibitor as the total refundable amount as computed above bears to the total amount of fees paid by all exhibitors.

Exhibit Booth Management and Dismantling Schedule

A representative must man exhibit space during all times when Exhibition is officially open. Exhibit space must be maintained in a neat and orderly manner throughout the Exhibition. Exhibitors may begin dismantling only after 3:00pm, Wednesday December 3. Move-out must be completed by 5:00pm, Wednesday, December 3. Exhibitors are responsible for removal of all materials used in their display. Any exhibitor leaving materials after 5:00pm, Wednesday December 3 will be charged for the materials' removal.

Failure to observe this rule, including early dismantling, will result in a €1,000 fine and may jeopardize the exhibitor's space assignments or right to exhibit at future conferences sponsored by IEEE/3DIC.

Loss or Damage

Exhibitor agrees with 3DIC 2014 that 3DIC 2014 shall not be liable for any damage or liability of any kind or for any loss, damage or injury to persons or property during the term of this agreement, from any cause whatsoever by reason of use, occupation and enjoyment of exhibit space by Exhibitor or any person thereof with the consent of Exhibitor, and that Exhibitor will defend, indemnify and save harmless, 3DIC 2014 from all liability whatsoever, on account of any such damage, or injury, whether or not caused by negligence or breach of an obligation by Exhibitor or its employees or representatives. Exhibitor will be liable for all damages or liability of any kind or for any loss, damage or injury to persons or any property during the show from any cause whatsoever by reason of use, occupation and enjoyment of exhibit space.

Demonstrations

No demonstrations or solicitations shall be permitted outside of the Exhibitor's assigned space, and no signs or placards may be displayed on persons or otherwise outside exhibit spaces.

Compliance

The Exhibitor assumes all responsibility for compliance with all pertinent ordinances, regulations and codes of duly authorized local and governmental bodies concerning fire, safety and health, together with the rules and regulations of the operators and/or owners of the property wherein the Show is held.

Management

The Exhibitor further agrees that the conditions, rules and regulations of the 3DIC 2014 management are made a part of this contract and that said Exhibitor agrees to be bound by each and all of these rules and regulations, and that the management shall have the full power to interpret, amend and enforce all rules and regulations in the best interest of the Show.

DISPLAY TABLE RESERVATION FORM

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December, 1-3
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COMPANY INFORMATION (as you want to appear in the conference program)

Company Name:		
Billing Contact:	Title	
Name of On-Site Contact:		
Mailing Address:		
City/State:	Country:	Zip
Phone Number:	Fax Number:	
Email:	Website:	

Conference registration and admission to social events is not included in exhibit fee

Please return form to: 3dic-conf-cork@tyndall.ie

Exhibit Fee payment and registration can be made at
<http://www.3dic-conf.org/registration/>